



TOL-504SWNC

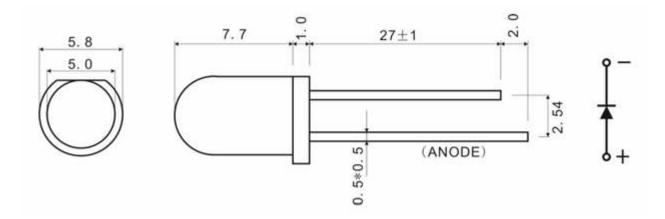
Lamp LED

Part Number		Chip		
r art Number	Material	Source Color	Lens Color	
TOL-504SWNC	InGaN	Snow White	Water Clear	

Features

- I.C. compatible.
- Low power consumption.
- Compatible with wave soldering process.
- 5mm diameter package.
- Long life, stable and reliable.
- RoHS compliant.

Dimensions



Notes:

- 1. All dimensions are in millimeter.
- 2. Tolerance is ± 0.25mm unless otherwise noted.

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Absolute Maximum Rating @ Ta=25°C

Parameter	Maximum Rating	Unit	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA	
Power Dissipation	100	mW	
Continuous Forward Current	30	mA	
Reverse Voltage	e 5		
Operating Temperature Range	-40°C to +80°C		
Storage Temperature Range	-40°C to +100°C		
Wave Soldering Profile For Lead-free Soldering	260°C for 5 Sec		

Electrical / Optical Characteristic @ Ta=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition	
Luminous Intensity	實際 Iv		-	11800	mcd	L =20m A	
Editifious intensity	降檔 lv	3000	-	6000	ilica	I _F =20mA	
Viewing Angle	201/2	-	45	-	deg	I _F =20mA	
Correlated Color Temperature	Тс	6000	-	18000	K	I _F =20mA	
Forward Voltage	V_{F}	2.8	-	3.4	V	I _F =20mA	
Reverse Current	I _R	-	-	10	μA	V _R =5V	
Chromaticity Coordinates	Х	0.249	-	0.311	-	I _F =20mA	
Chromaticity Cooldinates	Y	0.256	-	0.343	-	I _F =20mA	

^{*} Please refer to CIE 1931 chromaticity diagram.

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Bin Code List for Reference

Luminous Intensity (降檔對應表,使用倍率 Rate: 1.25) Unit: mcd@20mA					
Bin Code (實際亮度)	Min	Max	Bin Code (降檔亮度)	Min	Max
B48	6000	7500 💳	⇒ B45	3000	3800
B49	7500	9400 ⊏	⇒ B46	3800	4800
B50	9400	11800 🗀	⇒ B47	4800	6000

^{*} Tolerance of Luminous Intensity on each bin is ±15%.

Forward Voltage	Voltage Unit: V@20mA				
Bin Code	Min	Max			
V10	2.8	3.0			
V11	3.0	3.2			
V12	3.2	3.4			

Tolerance for each Forward Voltage Bin is ±0.1V

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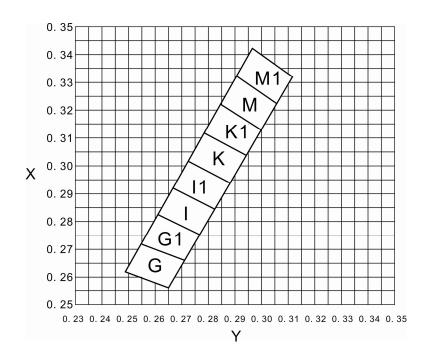
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Chromaticity Diagram

	х	Y	х	Y		х	Y	x	Y
G	0.249	0.263	0.255	0.273	G1	0.255	0.273	0.261	0.283
G	0.271	0.266	0.265	0.256	Gi	0.277	0.275	0.271	0.266
	0.261	0.283	0.267	0.293	14	0.267	0.293	0.273	0.303
•	0.282	0.285	0.277	0.275	11	0.288	0.294	0.282	0.285
K	0.273	0.303	0.278	0.313	K 1	0.278	0.313	0.284	0.323
, K	0.294	0.304	0.288	0.294	N.	0.300	0.313	0.294	0.304
М	0.284	0.323	0.290	0.333	M1	0.290	0.333	0.296	0.343
IVI	0.305	0.323	0.300	0.313	IVII	0.311	0.332	0.305	0.323



Color Coordinates Measurement allowance is ±0.01.

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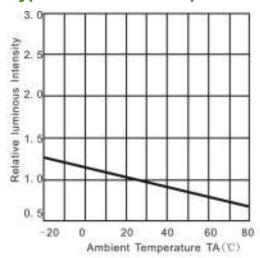
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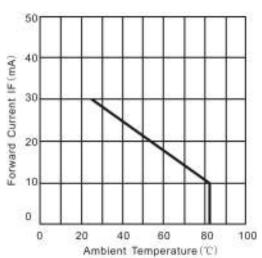
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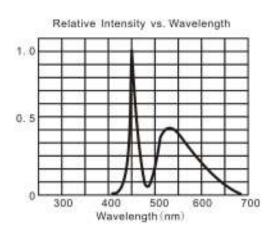


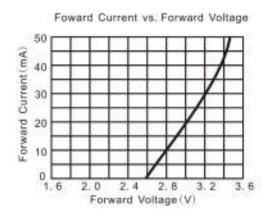


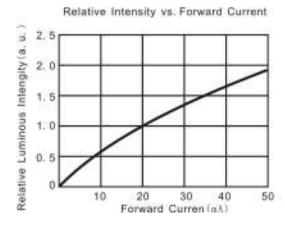
Typical Electrical / Optical Character Curves

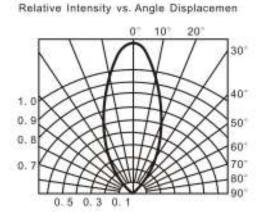












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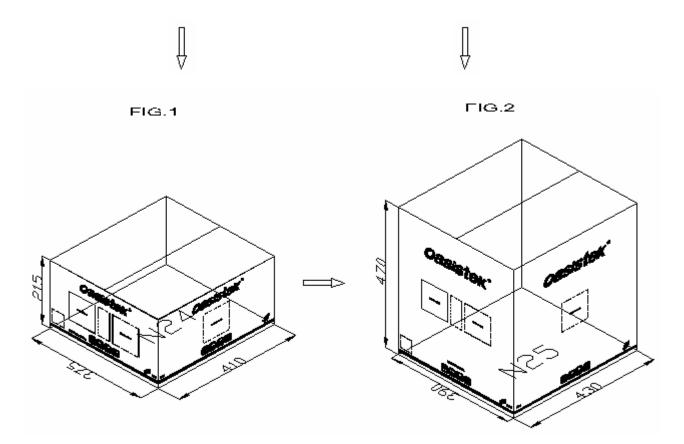




Package Description







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Reliability Test Project

Description	Item	Test criterion	Test condition	Test time	Qty	Fail Qty
Life test	Life test (Room temperature)	JIS7021:B4	Ta=25℃±5℃,IF=20mA	1000 Hrs	20	0
	High temperature store	JIS7021:B10 MIL-STD-202:210A MIL-STD-750:2031	:210A Ta=85°ℂ±5°ℂ		20	0
	Low temperature store	JIS7021:B12	Ta= -35°∁±5°∁	1000 Hrs	20	0
Ambience test	High temperature/ humidity test	JIS7021:B11 MIL-STD-202:103D	Ta=85°ℂ±5°ℂ RH=85%	1000 Hrs	20	0
	Cold / Heat strike test	JIS7021::B4 MIL-STD-202:107D MIL-STD-750:1026	30min -10°C±5°C ←→85°C±5°C 5min 5min	50 Cycles	20	0
	Cold and heat cycle test	JIS7021:A3 MIL-STD-202:107D MIL-STD-705:105E	5min 5min 5min -35°C ~25°C ~85°C ~-35°C 30min 5min 30min 5min	50 Cycles	20	0

Judging criterion

Itam	Symbol	Experiment	Crite	eria	
ltem	Symbol	condition	Min.	Max.	
Forward Voltage	VF	IF=20mA	-	Initial Datex1.1	
Reverse Current	IR	VR=5V	-	30μΑ	
Luminous Intensity	IV	IF=20mA	Initial Datex0.7	-	

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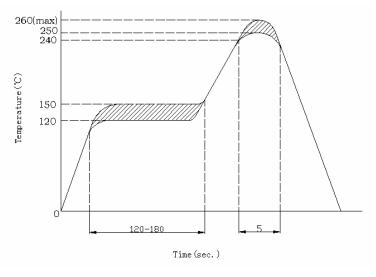


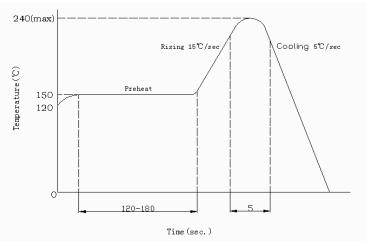
Cautions

- LED bracket forming method :
 - 1. The pin of led can be bent where is at least 3mm out of led colloid.
 - 2. Must use fixture to deform the led bracket.
 - 3. Finishing the forming of led bracket must be before soldering.
 - 4. Guarantee the gap between two pin of led tallys with LED pads in PCB when forming.
- Manual soldering :

The tip temperature of soldering iron don't exceed 260° C; soldering time don't exceed 3s and soldering position must be 3mm out of led colloid.

Soldering temperature curve chart (figure A \(\) figure B):





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ESD countermeasure

Static electricity and high volt can damage led. The production whose Die material is InGaN must strictly required to prevent ESD, must put on static glove and static fillet. Soldering tool and the cover of device must connect the ground, soldering condition follows the related stating of production specification manual.

Protecting countermeasure when over current

Need add the protecting resistor in circuit in order to avoid damaging led due to big current and voltage fluctuation.

LED installation method

- 1. Pay attention to the led polarity and avoid installation wrong. Led can't be close to euthermic component, work condition should tally with it's specification.
- 2. Don't install the LED under the condition of the led pin deformation.
- 3. The led bracket don't load any pressure when installing the led into PCB or fitting hole.
- 4. Must avoid any strike and force on led before the soldering temperature return to room temperature.

Storage time

1. LED can be stored for a year under the condition:

the temperature of 5° C \sim 35 $^{\circ}$ C and humidity of RH60%, These production must be re-inspected and tested before use if their storage time exceed a year.

2. If LED is exposed in air for a week under the condition:

the temperature of 5°C \sim 35°C, humidity of RH60%, must place the led in the ambience of 65°C±5°C for 24 hours and use it in 15 days for best.

Cleaning

Be careful of some chemical results in the led colloid fades and damage when using chemical clean the LED such as chloroethylene, acetone etc. can use ethanol to wash or soak LED but the time don't exceed 3 minutes.

Kinked

The kinked tooling scrape easily the pin of LED, where the led bracket is rusting easily, especial expose it in moist air. To decrease the led bracket rust, suggest using plated tin led bracket.

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